

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of

**OKAWA**Atty. Ref.: **1226-104**Serial No. **10/733,774**Group: **1711**Filed: **December 12, 2003**Examiner: **Mullis**For: **POLYOXYMETHYLENE RESIN-MADE STRETCHED PRODUCT AND  
PRODUCTION METHOD THEREOF**

\* \* \* \* \*

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**DECLARATION UNDER RULE 131**

Pursuant to 37 CFR §1.131, the undersigned, **Hidetoshi OKAWA**, hereby declares and states that:

1. I am the sole inventor of the invention disclosed and claimed in the above-identified U.S. patent application (hereinafter "the US '774 application").
2. I am also the sole inventor of the invention disclosed and claimed in Japanese Patent Application No. 2002-349793 filed on December 2, 2002 (hereinafter "the JP '793 application") which corresponds to the US '774 application and from which priority benefits under 35 USC §119 were not claimed.
3. A Supplemental Declaration under Rule 63 is attached as Exhibit A which identifies the prior filed JP '793 application for entry into the official record of the US '774 application.
4. The Japanese language text of the JP '793 application was filed on December 12, 2003 as the text of the US '774 application. A verified English-language translation

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**Serial No. 10/733,774**

of the JP '793 application, reformatted to include application headings and organized to otherwise comply with the formality requirements of U.S. Patent practice, was filed on May 10, 2004 as the English-language text of the US '774 application. Attached hereto as Exhibit B is a verified literal (non-reformatted) English-language translation of the JP '793 application. As is evident, the literal English-language translation of the JP '793 application attached as Exhibit B is substantively identical to the reformatted application text filed in the US '774 application on May 10, 2004.

5. Examples 1 through 11 in the JP '793 application are descriptions of polymer compositions in accordance with the invention claimed in the US '774 application that were actually made in Japan prior to the December 2, 2002 filing date of the JP '793 application but after January 1, 1996. Thus, as evidenced by Examples 1 through 11 in the JP '793 application, the invention as claimed in the US '774 application was reduced to practice at least as early as the December 2, 2002 filing date of the JP '793 application, but after January 1, 1996.

6. I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

July 8, 2005  
Date Signed

Hidetoshi Okawa  
Hidetoshi OKAWA